

SN54ABT843, SN74ABT843
9-BIT BUS-INTERFACE D-TYPE LATCHES
WITH 3-STATE OUTPUTS

SCBS197D – FEBRUARY 1991 – REVISED MAY 1997

- State-of-the-Art **EPIC-IITM** BiCMOS Design Significantly Reduces Power Dissipation
- Latch-Up Performance Exceeds 500 mA Per JEDEC Standard JESD-17
- Typical V_{OLP} (Output Ground Bounce) < 1 V at $V_{CC} = 5$ V, $T_A = 25^\circ\text{C}$
- High-Drive Outputs (-32 -mA I_{OH} , 64 -mA I_{OL})
- Package Options Include Plastic Small-Outline (DW) and Shrink Small-Outline (DB) Packages, Ceramic Chip Carriers (FK), Ceramic Flat (W) Package, and Plastic (NT) and Ceramic (JT) DIPs

description

The 'ABT843 9-bit latches are designed specifically for driving highly capacitive or relatively low-impedance loads. They are particularly suitable for implementing buffer registers, I/O ports, bidirectional bus drivers, and working registers.

The nine transparent D-type latches provide true data at the outputs.

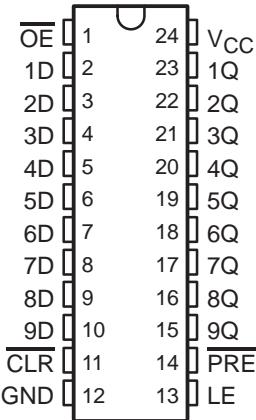
A buffered output-enable (\overline{OE}) input can be used to place the nine outputs in either a normal logic state (high or low logic levels) or a high-impedance state. The outputs are also in the high-impedance state during power-up and power-down conditions. The outputs remain in the high-impedance state while the device is powered down. In the high-impedance state, the outputs neither load nor drive the bus lines significantly. The high-impedance state and increased drive provide the capability to drive bus lines without need for interface or pullup components.

\overline{OE} does not affect the internal operations of the latch. Previously stored data can be retained or new data can be entered while the outputs are in the high-impedance state.

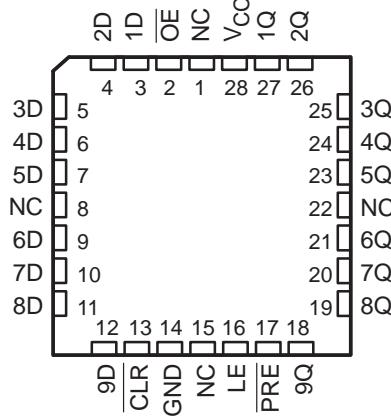
To ensure the high-impedance state during power up or power down, \overline{OE} should be tied to V_{CC} through a pullup resistor; the minimum value of the resistor is determined by the current-sinking capability of the driver.

The SN54ABT843 is characterized for operation over the full military temperature range of -55°C to 125°C . The SN74ABT843 is characterized for operation from -40°C to 85°C .

SN54ABT843 . . . JT OR W PACKAGE
SN74ABT843 . . . DB, DW, OR NT PACKAGE
(TOP VIEW)



SN54ABT843 . . . FK PACKAGE
(TOP VIEW)



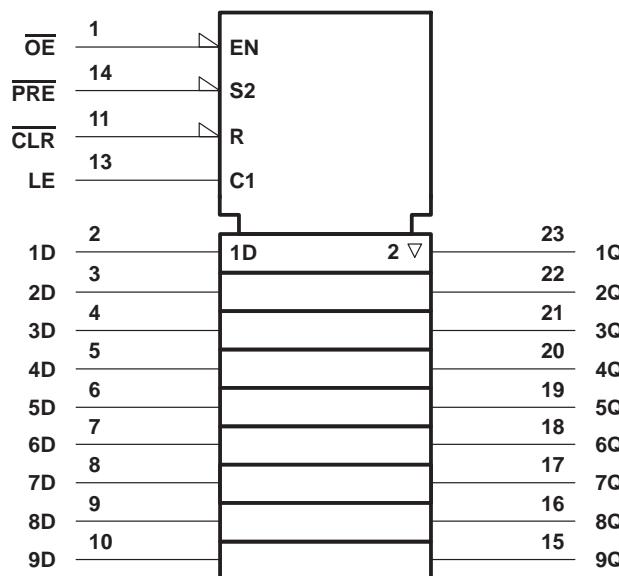
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SCBS197D – FEBRUARY 1991 – REVISED MAY 1997

FUNCTION TABLE

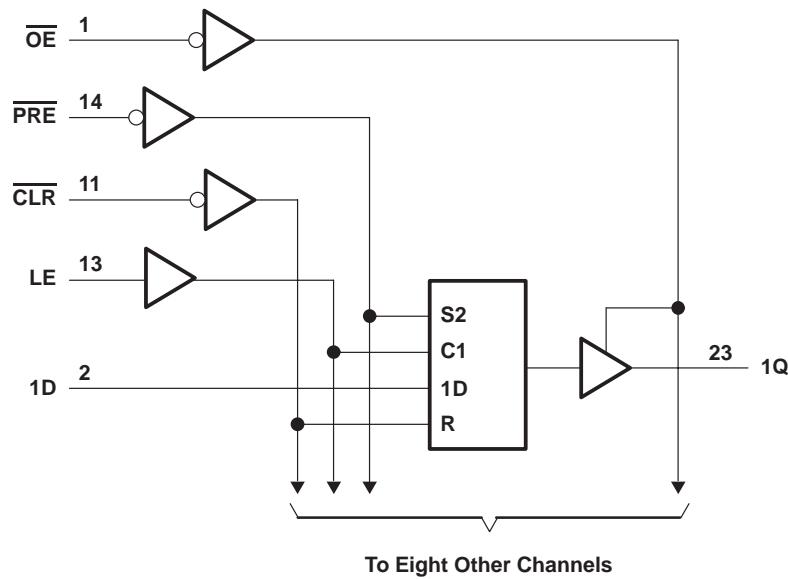
INPUTS					OUTPUT Q
PRE	CLR	\overline{OE}	LE	D	
L	X	L	X	X	H
H	L	L	X	X	L
H	H	L	H	L	L
H	H	L	H	H	H
H	H	L	L	X	Q_0
X	X	H	X	X	Z

logic symbol†



† This symbol is in accordance with ANSI/IEEE Std 91-1984 and IEC Publication 617-12.
Pin numbers shown are for the DB, DW, JT, NT, and W packages.

logic diagram (positive logic)



Pin numbers shown are for the DB, DW, JT, NT, and W packages.

absolute maximum ratings over operating free-air temperature range (unless otherwise noted)[†]

Supply voltage range, V_{CC}	-0.5 V to 7 V
Input voltage range, V_I (see Note 1)	-0.5 V to 7 V
Voltage range applied to any output in the high or power-off state, V_O	-0.5 V to 5.5 V
Current into any output in the low state, I_O : SN54ABT843	96 mA
SN74ABT843	128 mA
Input clamp current, I_{IK} ($V_I < 0$)	-18 mA
Output clamp current, I_{OK} ($V_O < 0$)	-50 mA
Package thermal impedance, θ_{JA} (see Note 2): DB package	104°C/W
DW package	81°C/W
NT package	67°C/W
Storage temperature range, T_{stg}	-65°C to 150°C

[†] Stresses beyond those listed under "absolute maximum ratings" may cause permanent damage to the device. This is a stress rating only, and functional operation of the device at these or any other conditions beyond those indicated in the "recommended operating conditions" section of this specification is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

NOTES: 1. The input and output negative-voltage ratings may be exceeded if the input and output clamp-current ratings are observed.
 2. The package thermal impedance is calculated in accordance with EIA/JEDEC Std JESD51, except for through-hole packages, which use a trace length of zero.

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SCBS197D – FEBRUARY 1991 – REVISED MAY 1997

recommended operating conditions (see Note 3)

		SN54ABT843		SN74ABT843		UNIT
		MIN	MAX	MIN	MAX	
V _{CC}	Supply voltage	4.5	5.5	4.5	5.5	V
V _{IH}	High-level input voltage	2		2		V
V _{IL}	Low-level input voltage		0.8		0.8	V
V _I	Input voltage	0	V _{CC}	0	V _{CC}	V
I _{OH}	High-level output current		-24		-32	mA
I _{OL}	Low-level output current		48		64	mA
Δt/Δv	Input transition rise or fall rate		5		5	ns/V
T _A	Operating free-air temperature	-55	125	-40	85	°C

NOTE 3: Unused inputs must be held high or low to prevent them from floating.

electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

PARAMETER	TEST CONDITIONS	T _A = 25°C			SN54ABT843	SN74ABT843	UNIT
		MIN	TYPT†	MAX	MIN	MAX	
V _{IK}	V _{CC} = 4.5 V, I _I = -18 mA			-1.2	-1.2	-1.2	V
V _{OH}	V _{CC} = 4.5 V, I _{OH} = -3 mA	2.5			2.5	2.5	V
	V _{CC} = 5 V, I _{OH} = -3 mA	3			3	3	
	V _{CC} = 4.5 V I _{OH} = -24 mA			2			
	I _{OH} = -32 mA	2*			2		
V _{OL}	V _{CC} = 4.5 V I _{OL} = 48 mA			0.55			V
				0.55*		0.55	
V _{hys}		100					mV
I _I	V _{CC} = 5.5 V, V _I = V _{CC} or GND		±1		±1	±1	µA
I _{OZH} ‡	V _{CC} = 5.5 V, V _O = 2.7 V		10		10	10	µA
I _{OZL} ‡	V _{CC} = 5.5 V, V _O = 0.5 V		-10		-10	-10	µA
I _{off}	V _{CC} = 0, V _I or V _O ≤ 4.5 V		±100			±100	µA
I _{CEX}	V _{CC} = 5.5 V, V _O = 5.5 V Outputs high		50		50	50	µA
I _O §	V _{CC} = 5.5 V, V _O = 2.5 V	-50	-140	-180	-50	-180	mA
I _{CC}	V _{CC} = 5.5 V, I _O = Open, V _I = V _{CC} or GND	Outputs high	1	250	250	250	µA
		Outputs low	24	34	34	34	mA
		Outputs disabled	0.5	250	250	250	µA
ΔI _{CC} ¶	V _{CC} = 5.5 V, One input at 3.4 V, Other inputs at V _{CC} or GND		1.5		1.5	1.5	mA
C _i	V _I = 2.5 V or 0.5 V		4				pF
C _O	V _O = 2.5 V or 0.5 V		7				pF

* On products compliant to MIL-PRF-38535, this parameter does not apply.

† All typical values are at V_{CC} = 5 V.

‡ The parameters I_{OZH} and I_{OZL} include the input leakage current.

§ Not more than one output should be tested at a time, and the duration of the test should not exceed one second.

¶ This is the increase in supply current for each input that is at the specified TTL voltage level rather than V_{CC} or GND.

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timing requirements over recommended ranges of supply voltage and operating free-air temperature (unless otherwise noted) (see Figures 1 and 2)

			$V_{CC} = 5 \text{ V}$, $T_A = 25^\circ\text{C}$		SN54ABT843		SN74ABT843		UNIT
			MIN	MAX	MIN	MAX	MIN	MAX	
t_W	Pulse duration	CLR low	5.5		5.5		5.5		ns
		$\overline{\text{PRE}}$ low	4.5		4.5		4.5		
		LE low	3.3		3.3		3.4		
t_{SU}	Setup time	Data before LE↓	Low	2.5	2.5	2.5	2.5	2.5	ns
			High	3	3	3	3	3	
		$\overline{\text{PRE}}$ inactive	1.6		1.6		1.6		
		CLR inactive	2		2		2		
t_h	Hold time, data after LE↓	High	1		1		1		ns
		Low	1.5†		2.3†		1.5†		

† This data sheet limit may vary among suppliers.

switching characteristics over recommended ranges of supply voltage and operating free-air temperature, $C_L = 50 \text{ pF}$ (unless otherwise noted) (see Figures 1 and 2)

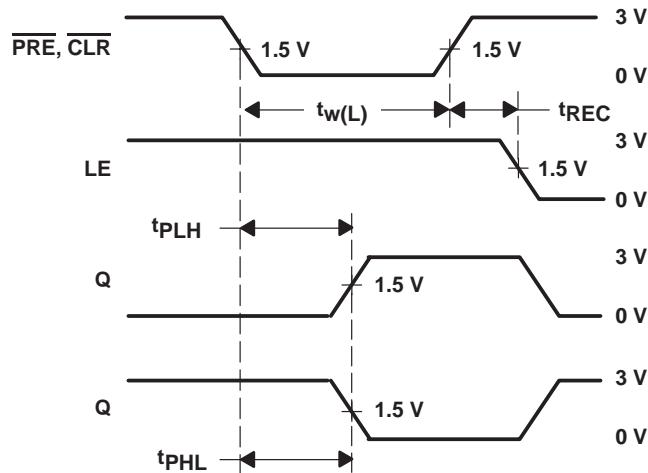
PARAMETER	FROM (INPUT)	TO (OUTPUT)	$V_{CC} = 5 \text{ V}$, $T_A = 25^\circ\text{C}$			SN54ABT843		SN74ABT843		UNIT
			MIN	TYP	MAX	MIN	MAX	MIN	MAX	
t_{PLH}	D	Q	1.2†	3.8	5.2	1.2†	7.8	1.2†	6.7†	ns
			1.5†	3.4	6.3	1.5†	7.3	1.5†	7.2	
t_{PLH}	LE	Q	1.7†	4.4	5.6	1.7†	8.3	1.7†	7.2†	ns
			1.9†	4.1	6.3	1.3†	7.2	1.9†	6.9	
t_{PLH}	$\overline{\text{PRE}}$	Q	2.2	5	6.2	2.2	8.3	2.2	7.4	ns
			2.1†	4.1	6.5	2.1†	7.5	2.1†	7.2	
t_{PLH}	$\overline{\text{CLR}}$	Q	2†	4.4	6.3	2†	7.6	2†	7.1	ns
			1.9†	4.5	6.8	1.9†	8.1	1.9†	8	
t_{PZH}	$\overline{\text{OE}}$	Q	1	3.4	4.5†	1	6.4	1	5.7†	ns
			2	4.3	5.7†	2	6.6	2	6.5	
t_{PHZ}	$\overline{\text{OE}}$	Q	2.4†	4.9	6.2	2.4†	7.3	2.4†	6.8	ns
			1.5†	4.2	6.3	1.5†	7	1.5†	5.9†	

† This data sheet limit may vary among suppliers.

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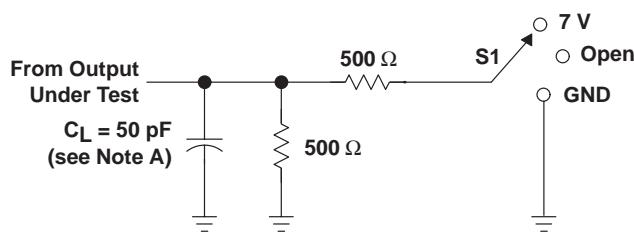
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recovery-time waveform

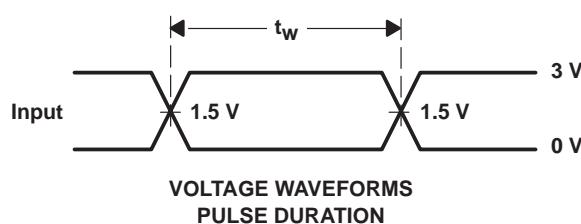


**Figure 1. $\overline{\text{CLR}}$ and $\overline{\text{PRE}}$ Pulse Duration, $\overline{\text{CLR}}$ and $\overline{\text{PRE}}$ to Output Delay,
and $\overline{\text{CLR}}$ and $\overline{\text{PRE}}$ to Latch-Enable Recovery Time**

PARAMETER MEASUREMENT INFORMATION

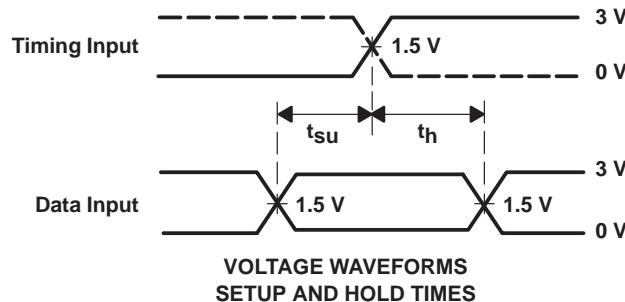


LOAD CIRCUIT

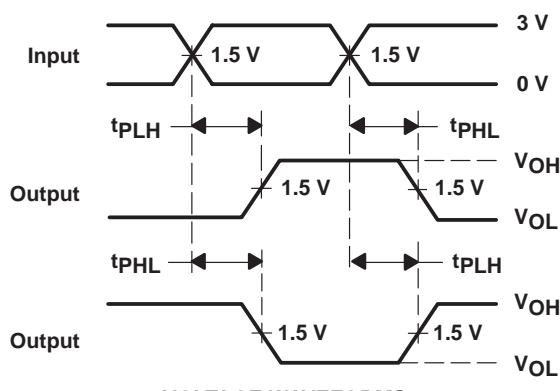


VOLTAGE WAVEFORMS
 PULSE DURATION

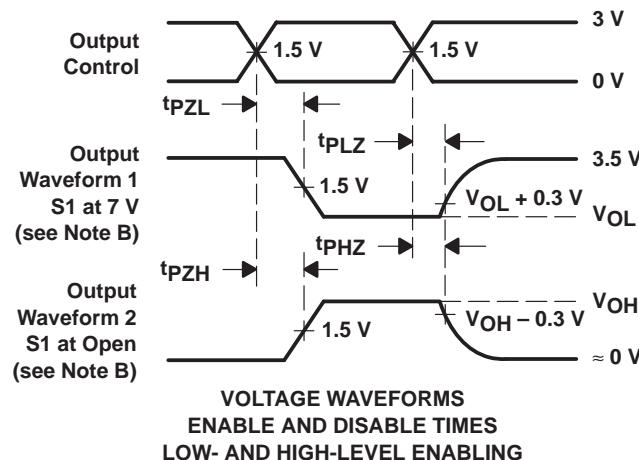
TEST	S1
t_{PLH}/t_{PHL}	Open
t_{PLZ}/t_{PZL}	7 V
t_{PHZ}/t_{PZH}	Open



VOLTAGE WAVEFORMS
 SETUP AND HOLD TIMES



VOLTAGE WAVEFORMS
 PROPAGATION DELAY TIMES
 INVERTING AND NONINVERTING OUTPUTS



VOLTAGE WAVEFORMS
 ENABLE AND DISABLE TIMES
 LOW- AND HIGH-LEVEL ENABLING

NOTES: A. C_L includes probe and jig capacitance.
 B. Waveform 1 is for an output with internal conditions such that the output is low except when disabled by the output control. Waveform 2 is for an output with internal conditions such that the output is high except when disabled by the output control.
 C. All input pulses are supplied by generators having the following characteristics: PRR \leq 10 MHz, $Z_O = 50 \Omega$, $t_r \leq 2.5$ ns, $t_f \leq 2.5$ ns.
 D. The outputs are measured one at a time with one transition per measurement.

Figure 2. Load Circuit and Voltage Waveforms

PACKAGING INFORMATION

Orderable part number	Status (1)	Material type (2)	Package Pins	Package qty Carrier	RoHS (3)	Lead finish/ Ball material (4)	MSL rating/ Peak reflow (5)	Op temp (°C)	Part marking (6)
5962-9571201QLA	Active	Production	CDIP (JT) 24	15 TUBE	No	SNPB	N/A for Pkg Type	-55 to 125	5962-9571201QL A SNJ54ABT843JT
SN74ABT843DBR	Active	Production	SSOP (DB) 24	2000 LARGE T&R	Yes	NIPDAU	Level-1-260C-UNLIM	-40 to 85	AB843
SN74ABT843DBR.B	Active	Production	SSOP (DB) 24	2000 LARGE T&R	Yes	NIPDAU	Level-1-260C-UNLIM	-40 to 85	AB843
SN74ABT843DW	Active	Production	SOIC (DW) 24	25 TUBE	Yes	NIPDAU	Level-1-260C-UNLIM	-40 to 85	ABT843
SN74ABT843DW.B	Active	Production	SOIC (DW) 24	25 TUBE	Yes	NIPDAU	Level-1-260C-UNLIM	-40 to 85	ABT843
SN74ABT843DWR	Active	Production	SOIC (DW) 24	2000 LARGE T&R	Yes	NIPDAU	Level-1-260C-UNLIM	-40 to 85	ABT843
SN74ABT843DWR.B	Active	Production	SOIC (DW) 24	2000 LARGE T&R	Yes	NIPDAU	Level-1-260C-UNLIM	-40 to 85	ABT843
SNJ54ABT843JT	Active	Production	CDIP (JT) 24	15 TUBE	No	SNPB	N/A for Pkg Type	-55 to 125	5962-9571201QL A SNJ54ABT843JT

⁽¹⁾ **Status:** For more details on status, see our [product life cycle](#).

⁽²⁾ **Material type:** When designated, preproduction parts are prototypes/experimental devices, and are not yet approved or released for full production. Testing and final process, including without limitation quality assurance, reliability performance testing, and/or process qualification, may not yet be complete, and this item is subject to further changes or possible discontinuation. If available for ordering, purchases will be subject to an additional waiver at checkout, and are intended for early internal evaluation purposes only. These items are sold without warranties of any kind.

⁽³⁾ **RoHS values:** Yes, No, RoHS Exempt. See the [TI RoHS Statement](#) for additional information and value definition.

⁽⁴⁾ **Lead finish/Ball material:** Parts may have multiple material finish options. Finish options are separated by a vertical ruled line. Lead finish/Ball material values may wrap to two lines if the finish value exceeds the maximum column width.

⁽⁵⁾ **MSL rating/Peak reflow:** The moisture sensitivity level ratings and peak solder (reflow) temperatures. In the event that a part has multiple moisture sensitivity ratings, only the lowest level per JEDEC standards is shown. Refer to the shipping label for the actual reflow temperature that will be used to mount the part to the printed circuit board.

⁽⁶⁾ **Part marking:** There may be an additional marking, which relates to the logo, the lot trace code information, or the environmental category of the part.

Multiple part markings will be inside parentheses. Only one part marking contained in parentheses and separated by a "~" will appear on a part. If a line is indented then it is a continuation of the previous line and the two combined represent the entire part marking for that device.

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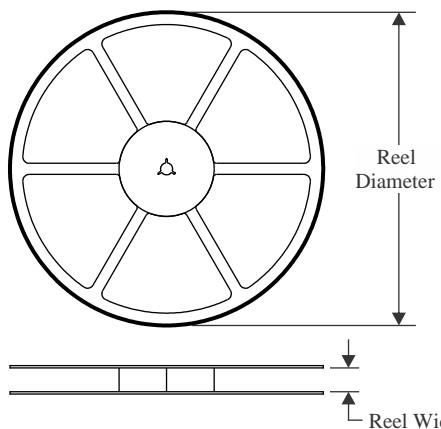
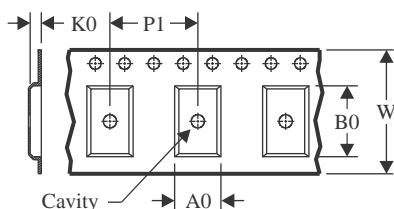
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OTHER QUALIFIED VERSIONS OF SN54ABT843, SN74ABT843 :

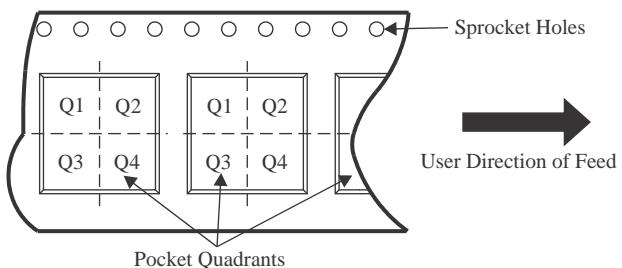
- Catalog : [SN74ABT843](#)
- Military : [SN54ABT843](#)

NOTE: Qualified Version Definitions:

- Catalog - TI's standard catalog product
- Military - QML certified for Military and Defense Applications

TAPE AND REEL INFORMATION
REEL DIMENSIONS

TAPE DIMENSIONS


A0	Dimension designed to accommodate the component width
B0	Dimension designed to accommodate the component length
K0	Dimension designed to accommodate the component thickness
W	Overall width of the carrier tape
P1	Pitch between successive cavity centers

QUADRANT ASSIGNMENTS FOR PIN 1 ORIENTATION IN TAPE


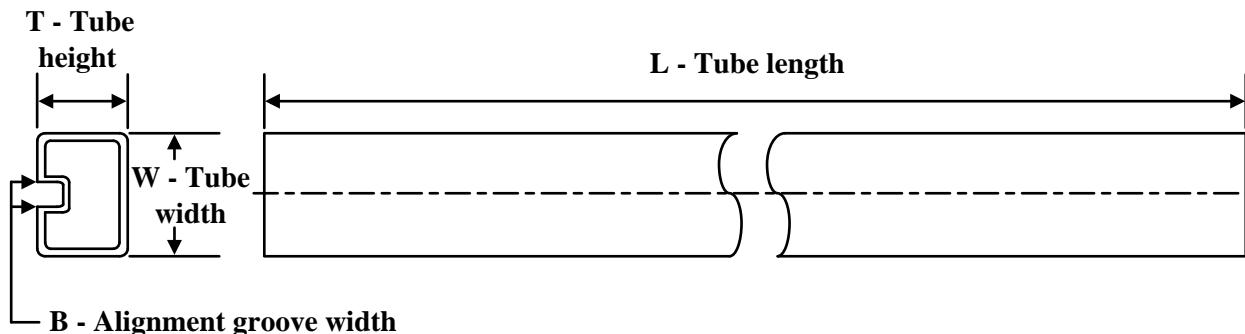
*All dimensions are nominal

Device	Package Type	Package Drawing	Pins	SPQ	Reel Diameter (mm)	Reel Width W1 (mm)	A0 (mm)	B0 (mm)	K0 (mm)	P1 (mm)	W (mm)	Pin1 Quadrant
SN74ABT843DBR	SSOP	DB	24	2000	330.0	16.4	8.2	8.8	2.5	12.0	16.0	Q1
SN74ABT843DWR	SOIC	DW	24	2000	330.0	24.4	10.75	15.7	2.7	12.0	24.0	Q1

TAPE AND REEL BOX DIMENSIONS


*All dimensions are nominal

Device	Package Type	Package Drawing	Pins	SPQ	Length (mm)	Width (mm)	Height (mm)
SN74ABT843DBR	SSOP	DB	24	2000	353.0	353.0	32.0
SN74ABT843DWR	SOIC	DW	24	2000	350.0	350.0	43.0

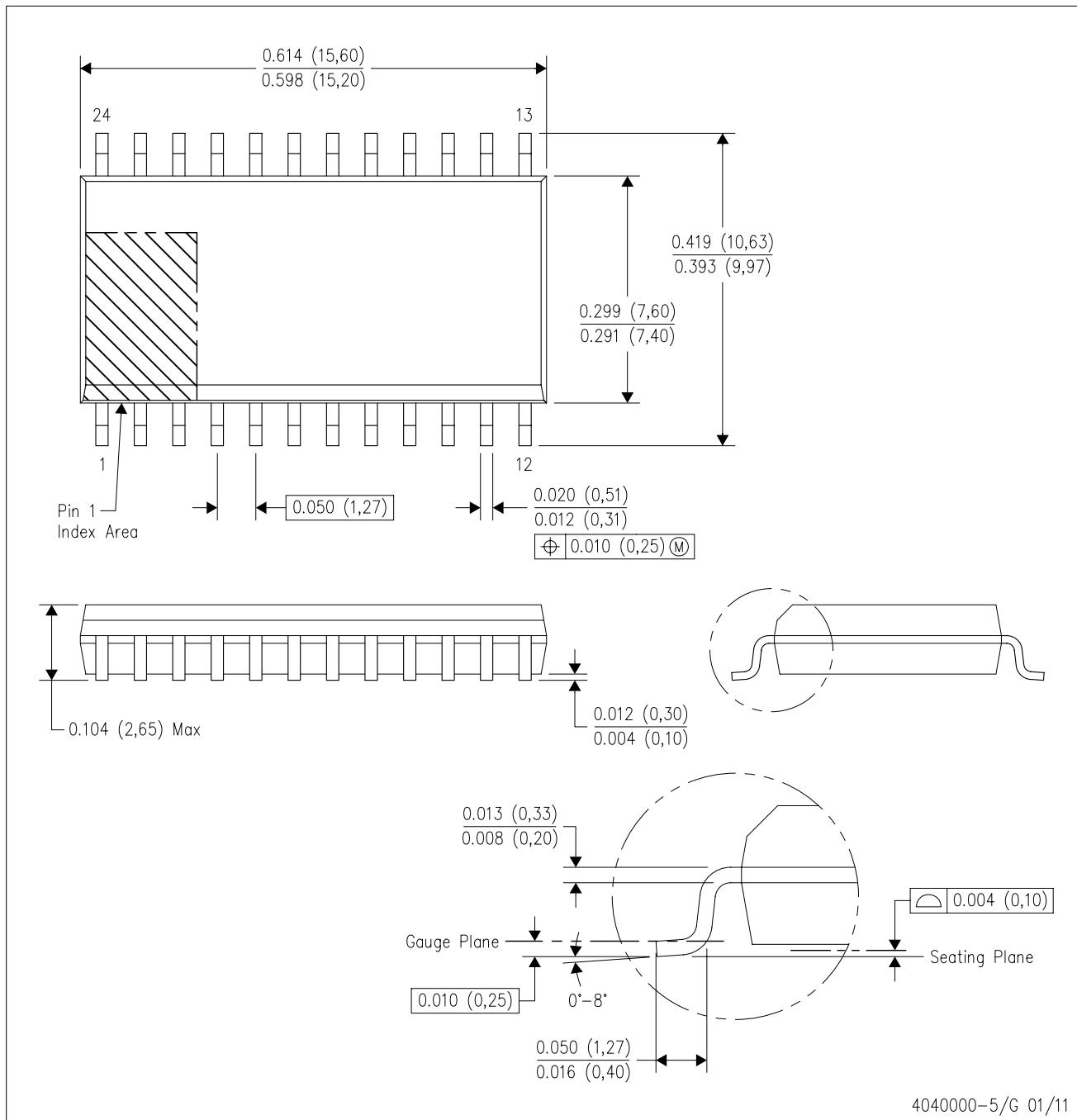
TUBE


*All dimensions are nominal

Device	Package Name	Package Type	Pins	SPQ	L (mm)	W (mm)	T (μ m)	B (mm)
SN74ABT843DW	DW	SOIC	24	25	506.98	12.7	4826	6.6
SN74ABT843DW.B	DW	SOIC	24	25	506.98	12.7	4826	6.6

DW (R-PDSO-G24)

PLASTIC SMALL OUTLINE

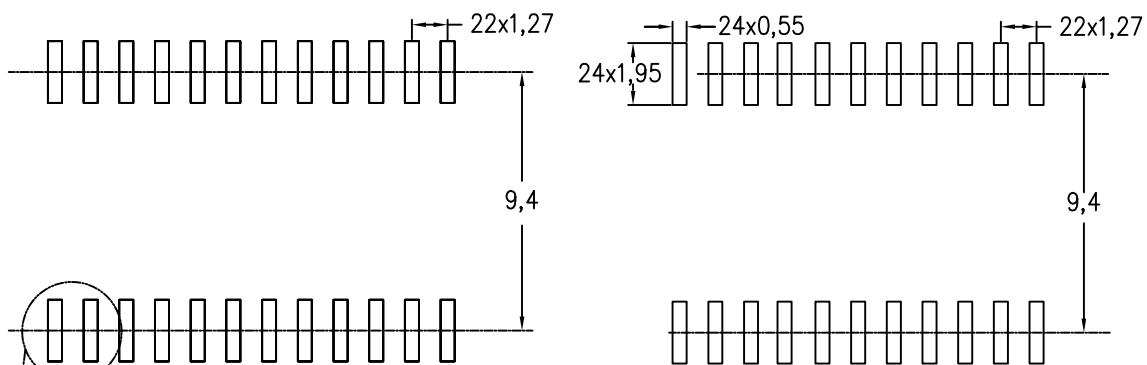


NOTES:

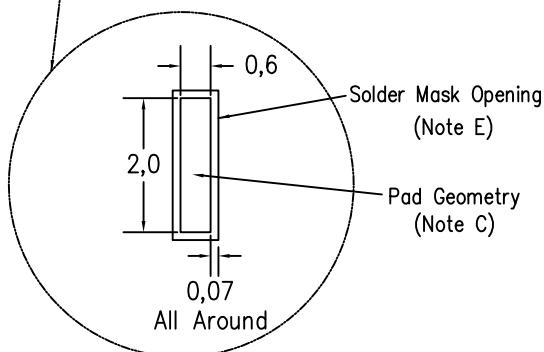
- All linear dimensions are in inches (millimeters). Dimensioning and tolerancing per ASME Y14.5M-1994.
- This drawing is subject to change without notice.
- Body dimensions do not include mold flash or protrusion not to exceed 0.006 (0.15).
- Falls within JEDEC MS-013 variation AD.

DW (R-PDSO-G24)

PLASTIC SMALL OUTLINE

Example Board Layout
(Note C)Stencil Openings
(Note D)

Non Solder Mask Define Pad



4209202-5/F 08/13

NOTES:

- All linear dimensions are in millimeters.
- This drawing is subject to change without notice.
- Refer to IPC7351 for alternate board design.
- Laser cutting apertures with trapezoidal walls and also rounding corners will offer better paste release. Customers should contact their board assembly site for stencil design recommendations. Refer to IPC-7525
- Customers should contact their board fabrication site for solder mask tolerances between and around signal pads.

DB (R-PDSO-G**)

PLASTIC SMALL-OUTLINE

28 PINS SHOWN

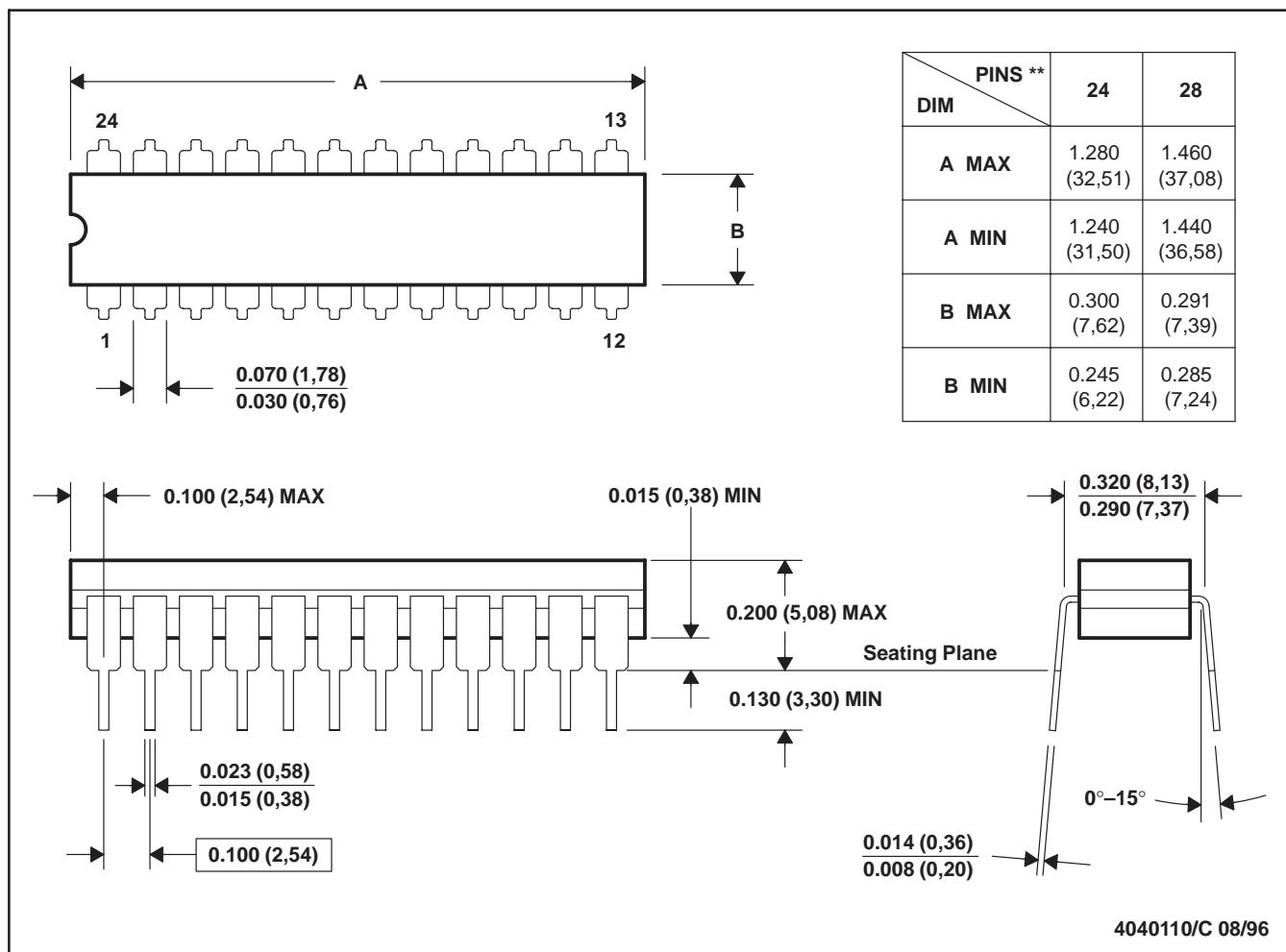


NOTES: A. All linear dimensions are in millimeters.
 B. This drawing is subject to change without notice.
 C. Body dimensions do not include mold flash or protrusion not to exceed 0,15.
 D. Falls within JEDEC MO-150

JT (R-GDIP-T**)

24 LEADS SHOWN

CERAMIC DUAL-IN-LINE



NOTES: A. All linear dimensions are in inches (millimeters).
 B. This drawing is subject to change without notice.
 C. This package can be hermetically sealed with a ceramic lid using glass frit.
 D. Index point is provided on cap for terminal identification.
 E. Falls within MIL STD 1835 GDIP3-T24, GDIP4-T28, and JEDEC MO-058 AA, MO-058 AB

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